

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage (Note 5)	Continuous	V_{GSS}	±20	V
Drain Current (Note 5)	Continuous Continuous @ +100°C Pulsed	I _D	115 73 800	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation	P _D	200	mW
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to +150	°C

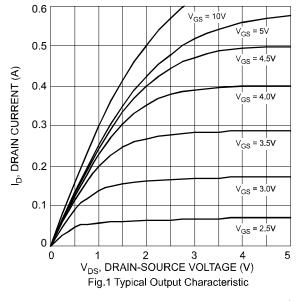
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

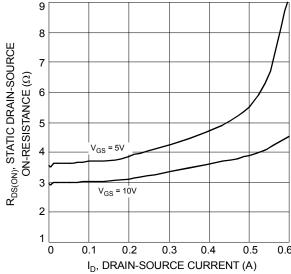
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)					•			
Drain-Source Breakdown Voltage		BV _{DSS}	60	70	_	V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	@ T _C = +25°C @ T _C = +125°C	I _{DSS}	_	_	1.0 500	μA	V _{DS} = 60V, V _{GS} = 0V	
Gate-Body Leakage		I _{GSS}	_	_	±5	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage		V _{GS(th)}	1.2		2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	@ T _J = +25°C	J	DS(ON) —	3.5	6	Ω	$V_{GS} = 5.0V, I_D = 0.115A$	
	@ T _J = +125°C	R _{DS(ON)}		3.0	5		V _{GS} = 10V, I _D = 0.115A	
Forward Transconductance		9 FS	80	_	_	mS	V _{DS} = 10V, I _D = 0.115A	
DYNAMIC CHARACTERISTICS (Note 7)					•			
Input Capacitance		C _{iss}	_	23	_	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance		Coss	_	3.4	_	pF		
Reverse Transfer Capacitance		C _{rss}		1.4	_	pF		
SWITCHING CHARACTERISTICS(Note 7)					•			
Turn-On Delay Time		t _{D(ON)}	_	10		ns	$V_{DD} = 30V$, $I_D = 0.115A$, $R_L = 150\Omega$,	
Turn-Off Delay Time		t _{D(OFF)}	_	33	_	ns	V_{GEN} = 10 $V_{,}$ R_{GEN} = 25 Ω	

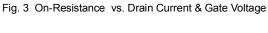
Notes

- 5. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Guaranteed by design. Not subject to production testing.









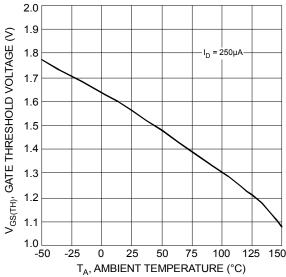
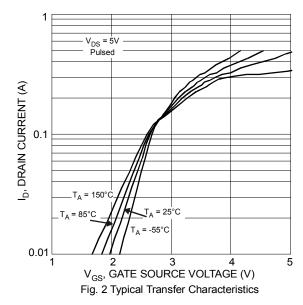


Fig. 5 Gate Threshold Variation vs. Ambient Temperature



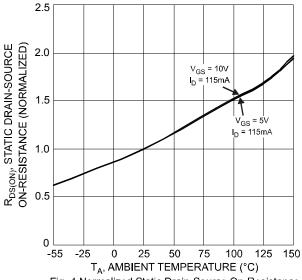
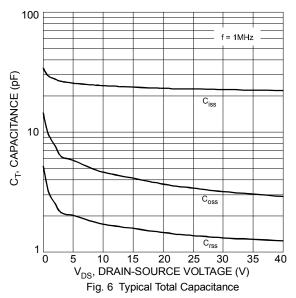


Fig. 4 Normalized Static Drain-Source On-Resistance vs. Ambient Temperature





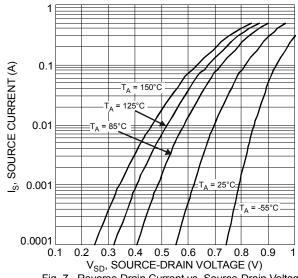
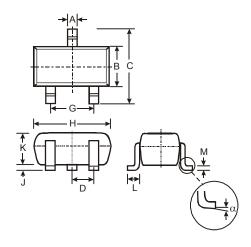


Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

Package Outline Dimensions

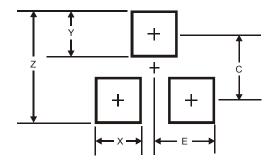
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT323					
Dim	Min	Max	Тур		
Α	0.25	0.40	0.30		
В	1.15	1.35	1.30		
C	2.00	2.20	2.10		
D	-	1	0.65		
G	1.20	1.40	1.30		
Η	1.80	2.20	2.15		
J	0.0	0.10	0.05		
K	0.90	1.00	1.00		
L	0.25	0.40	0.30		
M	0.10	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0



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